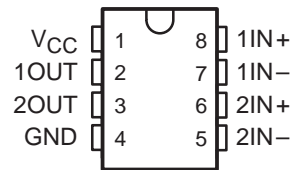


SN75146 DUAL DIFFERENTIAL LINE RECEIVER

SLLS015B – FEBRUARY 1986 – REVISED MAY 1995

- Meets or Exceeds the Requirements of ANSI EIA/TIA-422-B and -423-B
- Meets or Exceeds the Requirements of ANSI EIA/TIA-232-E and ITU Recommendation V.28 With External Components
- Meets Federal Standards 1020 and 1030
- Built-in 5-MHz Low-Pass Filter
- Operates From Single 5-V Power Supply
- Wide Common-Mode Voltage Range
- High Input Impedance
- TTL-Compatible Outputs
- 8-Pin Dual-in-Line Package
- Pinout Compatible With the μ A9637 and μ A9639

D OR P PACKAGE
(TOP VIEW)



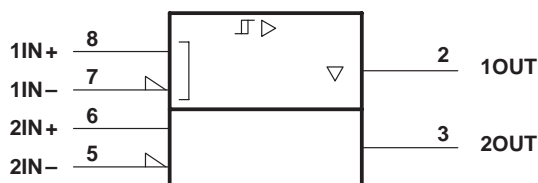
**THE SN75146 IS NOT RECOMMENDED
FOR NEW DESIGNS.**

description

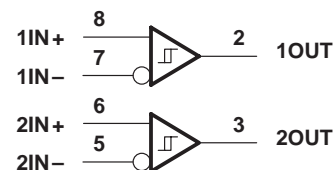
The SN75146 is a dual differential line receiver designed to meet ANSI Standards EIA/TIA-422-B and -423-B. The receiver is designed to have a constant impedance with input voltages of ± 3 V to ± 25 V allowing it to meet the requirements of EIA/TIA-232-E and ITU recommendation V.28 with the addition of an external bias resistor. This receiver is designed for low-speed operation below 355 kHz and has a built-in 5-MHz low-pass filter to attenuate high-frequency noise. The inputs are compatible with either a single-ended or a differential line system and the outputs are TTL compatible. This device operates from a single 5-V power supply and is supplied in both the 8-pin dual-in-line and small-outline packages.

The SN75146 is characterized for operation from 0°C to 70°C.

logic symbol†



logic diagram



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

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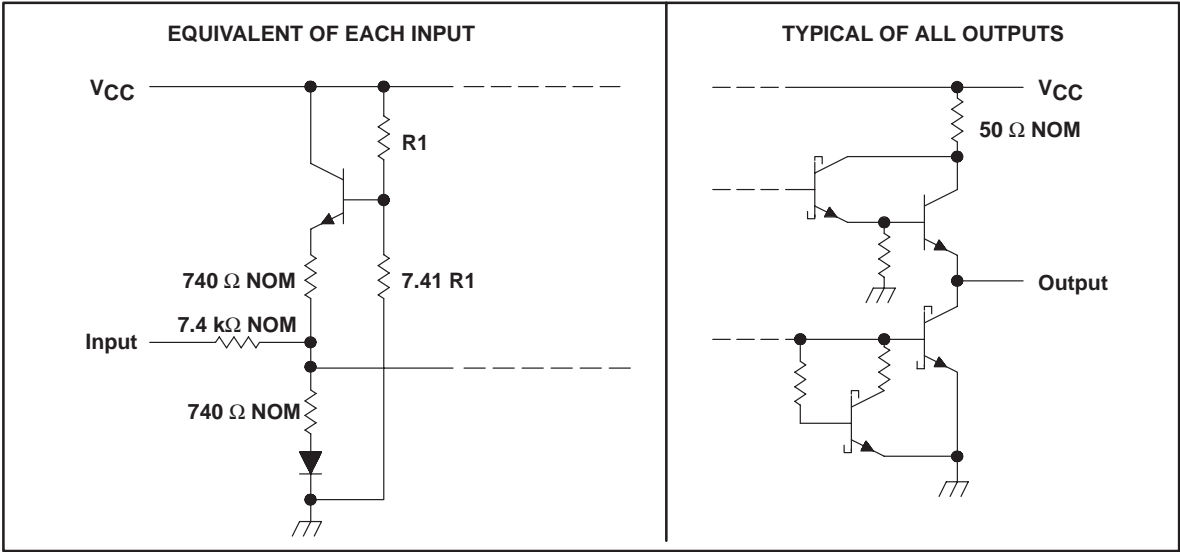
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SN75146

DUAL DIFFERENTIAL LINE RECEIVER

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schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC} (see Note 1)	−0.5 V to 7 V
Input voltage, V_I	±25 V
Differential input voltage, V_{ID} (see Note 2)	±25 V
Output voltage range, V_O (see Note 1)	−0.5 V to 5.5 V
Low-level output current, I_{OL}	50 mA
Continuous total dissipation	See Dissipation Rating Table
Operating free-air temperature range, T_A	0°C to 70°C
Storage temperature range, T_{stg}	− 65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, except differential input voltage, are with respect to the network ground terminal.
2. Differential input voltage is measured at the noninverting input with respect to the corresponding inverting input.

DISSIPATION RATING TABLE

PACKAGE	$T_A \leq 25^{\circ}\text{C}$ POWER RATING	OPERATING FACTOR ABOVE $T_A = 25^{\circ}\text{C}$	$T_A = 70^{\circ}\text{C}$ POWER RATING
D	725 mW	5.8 mW/°C	464 mW
P	1000 mW	8.0 mW/°C	640 mW

recommended operating conditions

	MIN	NOM	MAX	UNIT
Supply voltage, V_{CC}	4.75	5	5.25	V
Common-mode input voltage, V_{IC}			±7	V
Operating free-air temperature, T_A	0	25	70	°C

electrical characteristics over recommended ranges of supply voltage, common-mode input voltage, and operating free-air temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP†	MAX	UNIT
V_{IT} Threshold input voltage (V_{IT+} and V_{IT-})		-0.2‡		0.2	V
	See Note 3	-0.4‡		0.4	
V_{hys} Hysteresis ($V_{IT+} - V_{IT-}$)		70			mV
V_{IB} Input bias voltage	$I_I = 0$	2		2.4	V
V_{OH} High-level output voltage	$V_{ID} = 0.2$ V, $I_O = -1$ mA	2.5	3.5		V
V_{OL} Low-level output voltage	$V_{ID} = -0.2$ V, $I_O = 20$ mA		0.35	0.5	V
r_i Input resistance	$V_I = 3$ V to 25 V or $V_I = -3$ V to -25 V, See Note 4	6	7.8	10.5	k Ω
I_I Input current	$V_{CC} = 0$ to 5.5 V, See Note 5	$V_I = 10$ V	1.1	3.25	mA
		$V_I = -10$ V	-1.6	-3.25	
I_{OS} Short-circuit output current§	$V_O = 0$, $V_{ID} = 0.2$ V	-40	-75	-100	mA
I_{CC} Supply current	$V_{ID} = -0.5$ V, No load		35	50	mA

† All typical values are at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$.

‡ The algebraic convention, in which the less positive (more negative) limit is designated as minimum, is used in this data sheet for threshold levels only.

§ Only one output should be shorted at a time, and duration of the short circuit should not exceed one second.

NOTES: 3. The expanded threshold parameter is tested with a 500- Ω resistor in series with each input.

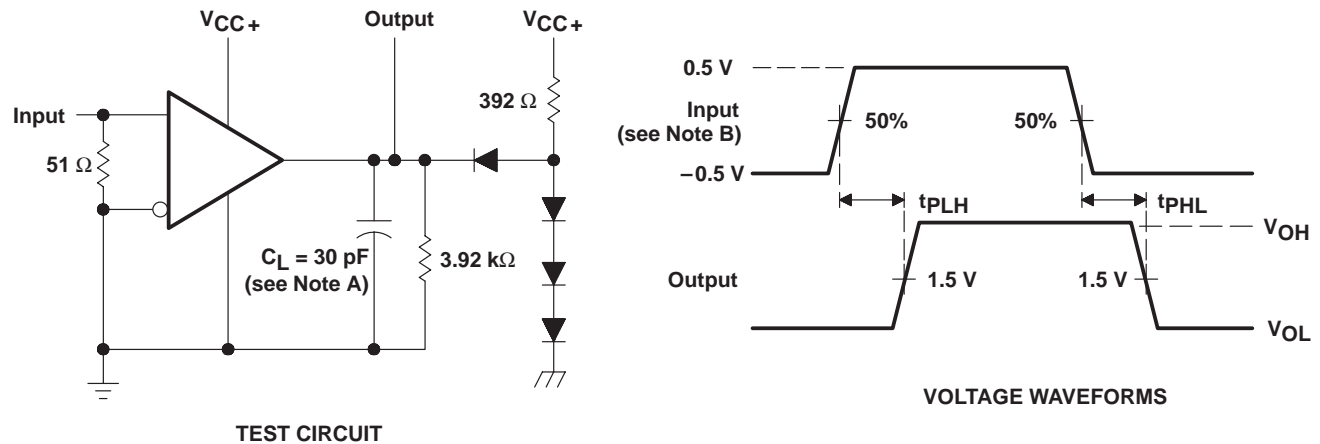
4. r_i is defined by $\Delta V_I / \Delta I_I$.

5. The input not under test is grounded.

switching characteristics, $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH} Propagation delay time, low-to-high-level output	$C_L = 30$ pF, See Figure 1	100	150	300	ns
t_{PHL} Propagation delay time, high-to-low-level output		100	150	300	ns

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

B. The input pulse is supplied by a generator having the following characteristics: $t_r \leq 5$ ns, $t_f \leq 5$ ns, PRR ≤ 300 kHz, duty cycle = 50%.

Figure 1. Test Circuit and Voltage Waveforms

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TYPICAL CHARACTERISTICS

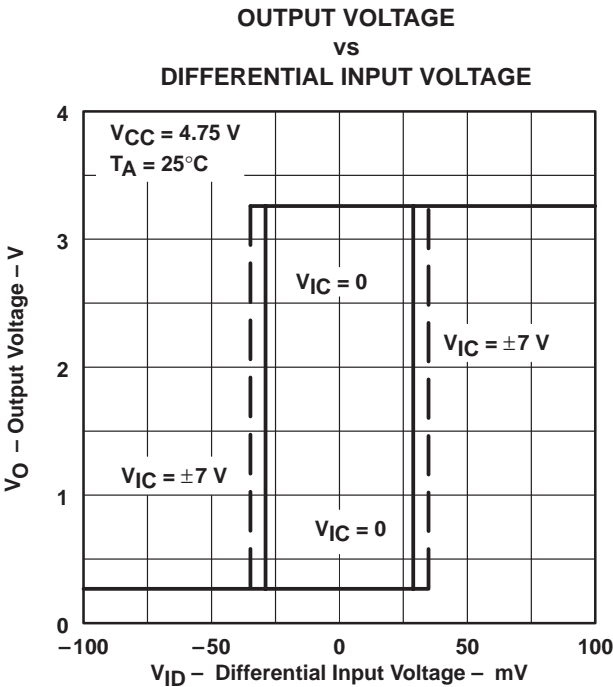


Figure 2

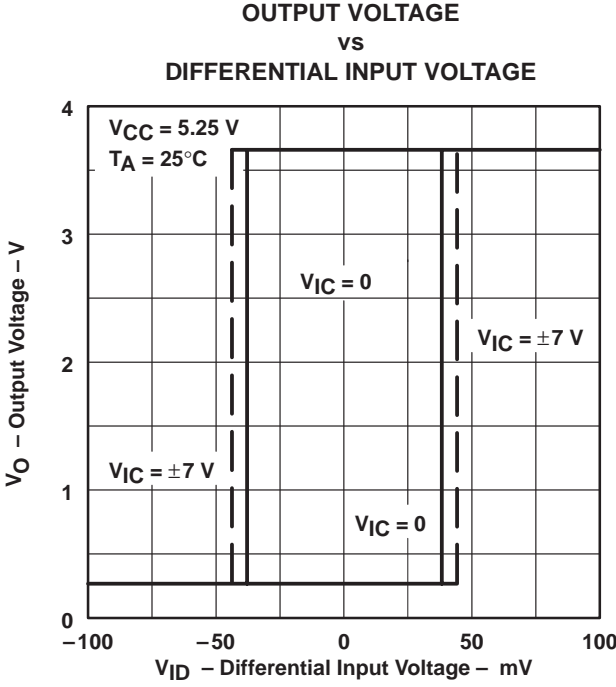
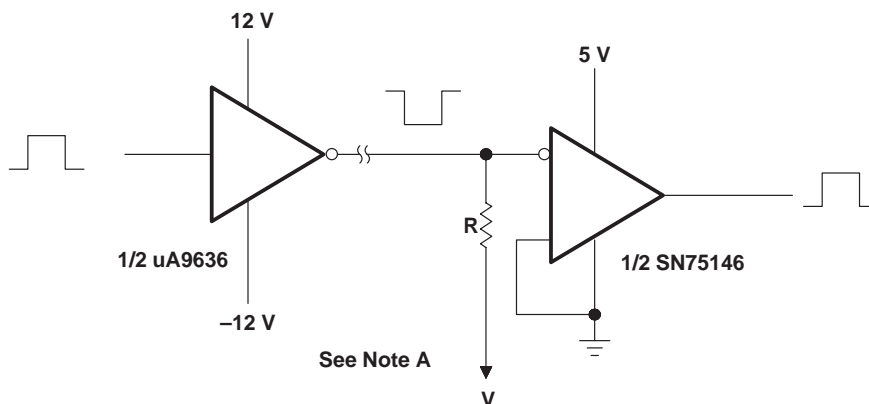


Figure 3

APPLICATION INFORMATION



NOTE A: In order to meet the input-impedance and open-circuit-input voltage requirements of ANSI Standard EIA/TIA-232-E and ITU recommendation V.28 and ensure open-circuit-input fail-safe operation, R and V are selected to satisfy the following equations:

$$V = -1.1 - 3.3 \frac{R}{r_i} \text{ volts}$$

$$3 \text{ k}\Omega \leq \frac{R(r_i)}{R + r_i} \leq 7 \text{ k}\Omega$$

Figure 4. EIA/TIA-232-E System Applications

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APPLICATION INFORMATION

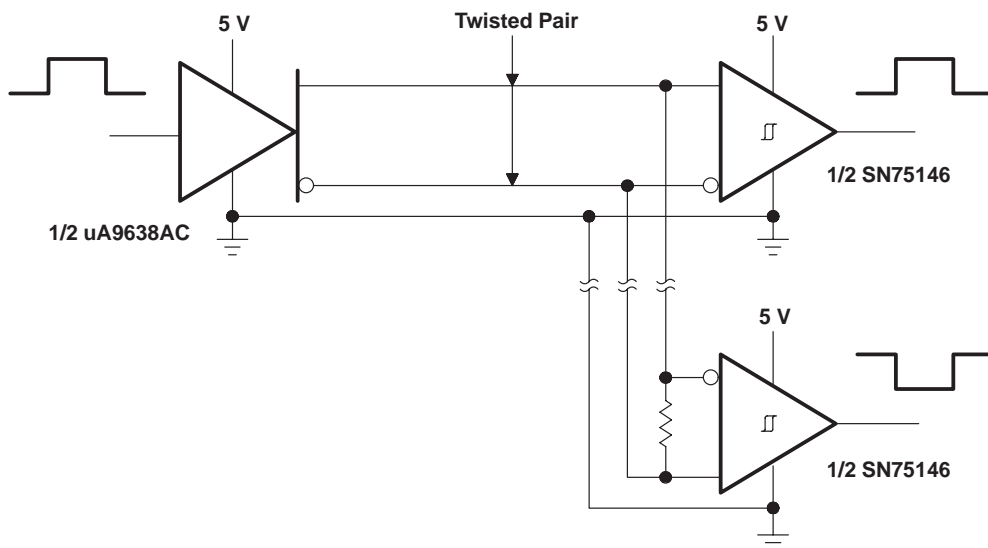


Figure 5. EIA/TIA-422-B System Applications

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
SN75146D	NRND	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	Samples Not Available
SN75146DE4	NRND	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	Samples Not Available
SN75146DG4	NRND	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	Samples Not Available
SN75146P	OBSOLETE	PDIP	P	8		TBD	Call TI	Call TI	Samples Not Available

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Falls within JEDEC MS-001 variation BA.

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - $\triangle C$ Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
 - $\triangle D$ Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
 - E. Reference JEDEC MS-012 variation AA.

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Publication IPC-7351 is recommended for alternate designs.
 - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

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